

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5241612

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUSAKU OKAJIMA	10/25/2018
SHUHEI SAIDO	10/25/2018
HIDENARI YOSHIDA	10/25/2018
TAKAFUMI SASAKI	10/25/2018
RECEIVING PARTY DATA	
Name:	KOKUSAI ELECTRIC CORPORATION
Street Address:	5TH FLOOR, OAK KANDA KAJICHO BUILDING, 3-4 KANDA KAJI-CHO, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	101-0045
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29670537
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NAME OF SUBMITTER:	ALAN E. SCHIAVELLI
SIGNATURE:	/Alan E. Schiavelli/
DATE SIGNED:	11/16/2018
Total Attachments: 1	
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by KOKUSAI ELECTRIC CORPORATION,
a corporation organized under the laws of Japan,
located at 3-4 Kanda Kaji-cho, Chiyoda-ku, Tokyo 101-0045, Japan
receipt of which is hereby acknowledged I do hereby sell and assign to said KOKUSAI ELECTRIC CORPORATION.
its successor and assigns, all my right, title and interest, in and for the United States of America, in and to

COVER OF SEAL CAP FOR RECTION CHAMBER FOR SEMICONDUCTOR

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,
to be held and enjoyed by said KOKUSAI ELECTRIC CORPORATION.
its successor, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said KOKUSAI ELECTRIC CORPORATION.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Yusaku Okajima Yusaku OKAJIMA

October 25, 2018

2) Shuhei Saito Shuhei SAITO

October 25, 2018

3) Hiddenari Yoshida Hiddenari YOSHIDA

October 25, 2018

4) Takafumi Sasaki Takafumi SASAKI

October 25, 2018